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1/3, 1/4-Duty LCD Driver with Key Input Function

Overview

The LC75857E and LC75857W are 1/3 duty and 1/4 duty LCD display drivers that can directly drive up to 164 segments and can control up to four general-purpose output ports. These products also incorporate a key scan circuit that accepts input from up to 30 keys to reduce printed circuit board wiring.

Features

- Key input function for up to 30 keys (A key scan is performed only when a key is pressed.)
- 1/3 duty and 1/4 duty drive schemes can be controlled from serial data.
- 1/2 bias and 1/3 bias drive schemes can be controlled from serial data.
- Capable of driving up to 126 segments using 1/3 duty and up to 164 segments using 1/4 duty.
- Sleep mode and all segments off functions that are controlled from serial
- Switching between key scan output and segment output can be controlled from the serial data.
- The key scan operation enabled/disabled state can be controlled from the serial data.
- Switching between segment output port and general-purpose output port can be controlled from serial data.
- The common and segment output waveform frame frequency can be controlled from the serial data.
- Switching between RC oscillator mode and external clock mode can be controlled from the serial data.
- Serial data I/O supports CCB* format communication with the system controller.
- Direct display of display data without the use of a decoder provides high generality.
- Independent VLCD for the LCD driver block. (When the logic block supply voltage VDD is in the range 3.6 to 6.0 V, VLCD can be set to a voltage in the range 0.75 × VDD to 6.0 V, and when VDD is in the range 2.7 to 3.6 V, VLCD can be set to a voltage in the range 2.7 to 6.0 V.)
- Provision of an on-chip voltage-detection type reset circuit prevents incorrect displays.



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PQFP64 14x14 / QIP64E [LC75857E]



SPQFP64 10x10 / SQFP64 [LC75857W]

ORDERING INFORMATION

See detailed ordering and shipping information on page 42 of this data sheet.

^{*} Computer Control Bus (CCB) is an ON Semiconductor's original bus format and the bus addresses are controlled by ON Semiconductor.

Specifications

Absolute Maximum Ratings at Ta=25 $^{\circ}$ C, V_{SS} =0V

Parameter	Symbol	Conditions	Ratings	Unit
Mariana	V _{DD} max	V_{DD}	-0.3 to +7.0	V
Maximum supply voltage	V _{LCD} max	V _{LCD}	-0.3 to +7.0	
	V _{IN} 1	CE, CL, DI	-0.3 to +7.0	
Input voltage	V _{IN} 2	OSC,TEST	-0.3 to V _{DD} +0.3	V
	V _{IN} 3	V _{LCD} 1, V _{LCD} 2, KI1 to KI5	-0.3 to V _{LCD} +0.3	
	V _{OUT} 1	DO	-0.3 to +7.0	
Output voltage	V _{OUT} 2	OSC	-0.3 to V _{DD} +0.3	V
	V _{OUT} 3	S1 to S42, COM1 to COM4, KS1 to KS6, P1 to P4	-0.3 to V _{LCD} +0.3	
	I _{OUT} 1	S1 to S42	300	μA
Outrot summer	I _{OUT} 2	COM1 to COM4	3	
Output current	I _{OUT} 3	KS1 to KS6	1	mA
	I _{OUT} 4	P1 to P4	5	
Allowable power dissipation	Pd max	Ta = 85°C	200	mW
Operating temperature	Topr		-40 to +85	°C
Storage temperature	Tstg		-55 to +125	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Allowable Operating Ranges at Ta = -40 to +85°C, $V_{SS}=0V$

Parameter	Symbol	Conditions		Ratings			Unit
Parameter	Symbol	Conditions		min	typ	max	Unit
	V_{DD}	V _{DD}		2.7		6.0	
Supply voltage	V	V _{LCD} : V _{DD} = 3.6 V to 6.0 V		$0.75\ V_{DD}$		6.0	V
	V _{LCD}	V _{LCD} : V _{DD} = 2.7 V to 3.6 V		2.7		6.0	
Input voltage	V _{LCD} 1	V _{LCD} 1			2/3 V _{LCD}	V_{LCD}	V
input voltage	V _{LCD} 2	V _{LCD} 2			1/3 V _{LCD}	V_{LCD}	v
	V _{IH} 1	CE, CL, DI		$0.8~V_{DD}$		6.0	
Input high level voltage	V _{IH} 2	KI1 to KI5		0.6 V _{LCD}		V _{LCD}	V
	V _{IH} 3	OSC: External clock mode		0.7 V _{DD}		V_{DD}	
	V _{IL} 1	CE, CL, DI		0		0.2 V _{DD}	
Input low level voltage	V _{IL} 2	KI1 to KI5		0		0.2 V _{LCD}	V
	V _{IL} 3	OSC: External clock mode		0		0.3 V _{DD}	
Recommended RC oscillator external resistor	Rosc	OSC: RC oscillator mode			39		kΩ
Recommended RC oscillator external capacitor	Cosc	OSC: RC oscillator mode			1000		pF
Guaranteed RC oscillator operating range	fosc	OSC: RC oscillator mode		19	38	76	kHz
External clock frequency	f _{CK}	OSC: External clock mode	:Figure 4	19	38	76	kHz
External clock duty	D _{CK}	OSC: External clock mode	:Figure 4	30	50	70	%
Data setup time	t _{ds}	CL, DI	:Figures 2,3	160			ns
Data hold time	t _{dh}	CL, DI	:Figures 2,3	160			ns
CE wait time	t _{cp}	CE, CL	:Figures 2,3	160			ns
CE setup time	t _{cs}	CE, CL	:Figures 2,3	160			ns
CE hold time	t _{ch}	CE, CL	:Figures 2,3	160			ns
High level clock pulse width	tø _H	CL	:Figures 2,3	160			ns
Low level clock pulse width	tø∟	CL	:Figures 2,3	160			ns
Rise time	t _r	CE, CL, DI	:Figures 2,3		160		ns
Fall time	t _f	CE, CL, DI	:Figures 2,3		160		ns
DO output delay time	t _{dc}	DO R _{PU} =4.7 kΩ, C _L =10pF *1	:Figures 2,3			1.5	μs
DO rise time	t _{dr}	DO R _{PU} =4.7 kΩ, C _L =10pF *1	:Figures 2,3			1.5	μs

Note: *1. Since DO is an open-drain output, these values depend on the resistance of the pull-up resistor R_{PU} and the load capacitance C_L.

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

Electrical Characteristics for the Allowable Operation Ranges

Parameter	Symbol	Conditions		Unit			
Falametei	Symbol	Conditions	min	typ	max	Ullit	
Hysteresis	V _{H1}	CE, CL, DI		0.1 V _{DD}		V	
nysteresis	V _{H2}	KI1 to KI5		0.1 V _{LCD}		V	
Power-down detection voltage	V _{DET}		2.0	2.2	2.4	V	
Input high lavel gurrent	I _{IH} 1	CE, CL, DI: V _I = 6.0 V			5.0		
Input high level current	I _{IH} 2	OSC: V _I = V _{DD} External clock mode			5.0	μA	
Innut law level ourrent	I _{IL} 1	CE, CL, DI: V _I = 0 V	-5.0				
Input low level current	I _{IL} 2	OSC: V _I = 0 V External clock mode	-5.0			μA	
Input floating voltage	V _{IF}	KI1 to KI5			0.05 V _{LCD}	V	
Dull dama accistance		KI1 to KI5: V _{LCD} = 5.0 V	50	100	250	l-o	
Pull-down resistance	R _{PD}	KI1 to KI5: V _{LCD} = 3.0 V	100	200	500	kΩ	
Output off leakage current	I _{OFFH}	DO: VO = 6.0 V			6.0	μA	
	V 4	KS1 to KS6: $I_O = -500 \mu A V_{LCD} = 3.6 \text{ to } 6.0 \text{ V}$	V _{LCD} – 1.0	V _{LCD} - 0.5	V _{LCD} - 0.2		
	V _{OH} 1	KS1 to KS6: $I_O = -250 \mu A V_{LCD} = 2.7 \text{ to } 3.6 \text{ V}$	V _{LCD} – 0.8	V _{LCD} - 0.4	V _{LCD} - 0.1		
Output high level voltage	V _{OH} 2	P1 to P4: I _O = -1 mA	V _{LCD} – 0.9			V	
	V _{OH} 3	S1 to S42: I _O = –20 μA	V _{LCD} – 0.9				
	V _{OH} 4	COM1 to COM4: I _O = -100 μA	V _{LCD} – 0.9				
	V 4	KS1 to KS6: I_O = 25 μ A V_{LCD} = 3.6 to 6.0 V	0.2	0.5	1.5		
	V _{OL} 1	KS1 to KS6: I_0 = 12.5 μ A V_{LCD} = 2.7 to 3.6 V	0.1	0.4	1.2		
Outrot level walks	V _{OL} 2	P1 to P4: I _O = 1 mA			0.9	V	
Output low level voltage	V _{OL} 3	S1 to S42: I _O = 20 μA			0.9	v	
	V _{OL} 4	COM1 to COM4: I _O = 100 µA			0.9		
	V _{OL} 5	DO: I _O = 1 mA		0.1	0.5		
	V _{MID} 1	COM1 to COM4: 1/2 bias, I _O = ±100 μA	1/2 V _{LCD} - 0.9		1/2 V _{LCD} + 0.9		
	V _{MID} 2	S1 to S42: 1/3 bias,I _O = ±20 μA	2/3 V _{LCD} - 0.9		2/3 V _{LCD} + 0.9		
Output middle level voltage *2	V _{MID} 3	S1 to S42: 1/3 bias, I _O = ±20 μA	1/3 V _{LCD} - 0.9		1/3 V _{LCD} + 0.9	V	
	V _{MID} 4	COM1 to COM4: $1/3$ bias, $I_O = \pm 100 \mu A$	2/3 V _{LCD} - 0.9		2/3 V _{LCD} + 0.9		
	V _{MID} 5	COM1 to COM4: $1/3$ bias, $I_O = \pm 100 \mu A$	1/3 V _{LCD} - 0.9		1/3 V _{LCD} + 0.9		
Oscillator frequency	fosc	OSC: R _{OSC} = 39 kΩ, C _{OSC} = 1000 pF	30.4	38	45.6	kHz	
	I _{DD} 1	V _{DD} :Sleep mode			100		
	I _{DD} 2	V _{DD} : V _{DD} = 6.0 V, output open,fosc = 38 kHz		300	600		
	I _{LCD} 1	V _{LCD} : Sleep mode			5		
Current drain	I _{LCD} 2	V _{LCD} : V _{LCD} = 6.0 V, output open, 1/2 bias, fosc = 38 kHz		100	200	μA	
	I _{LCD} 3	V _{LCD} : V _{LCD} = 6.0 V, output open, 1/3 bias, fosc = 38 kHz		60	120		

Nete: *2. Excluding the bias voltage generation divider resistor built into $V_{LCD}1$ and $V_{LCD}2$. (See Figure 1.)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

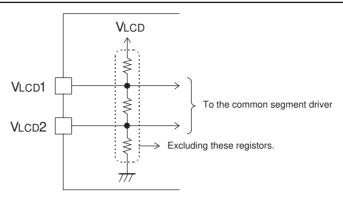


Figure 1

1. Serial data I/O timing when CL is stopped at the low level

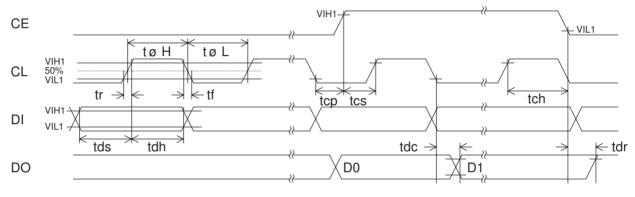


Figure 2

2. Serial data I/O timing when CL is stopped at the high level

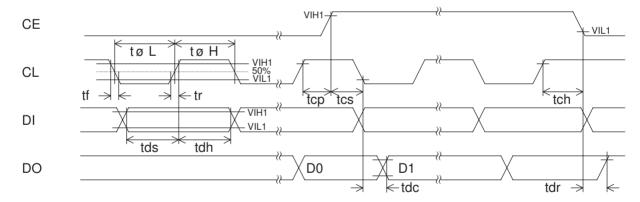


Figure 3

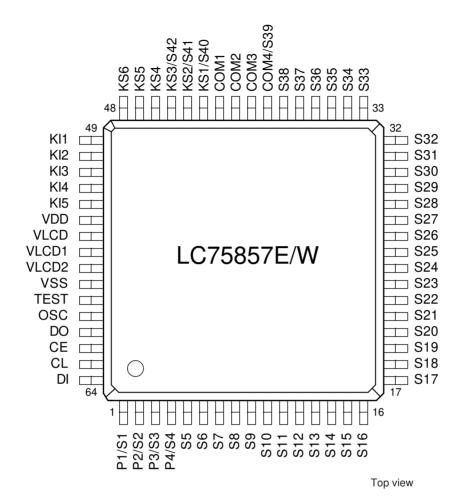
3. OSC pin clock timing in external clock mode

OSC
$$\frac{\text{VIH3}}{\text{VIL3}} \text{ DCK} = \frac{1}{\text{tCKH} + \text{tCKL}} [\text{kHz}]$$

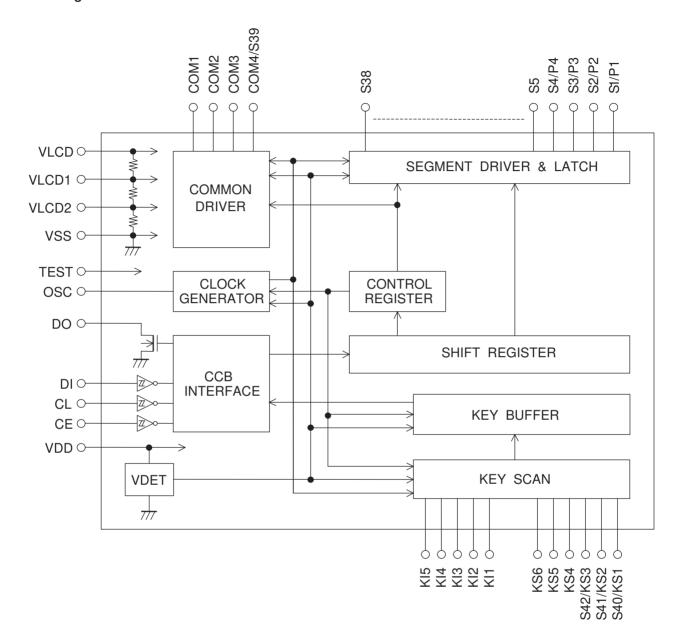
$$\text{DCK} = \frac{\text{tCKH}}{\text{tCKH} + \text{tCKL}} \times 100[\%]$$

Figure 4

Pin Assignments

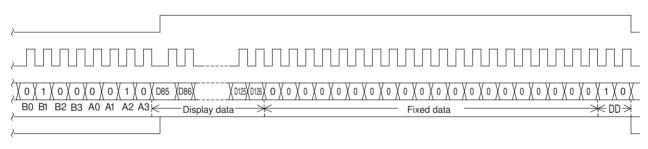


Block Diagram



Pin Functions

Pin	Pin No.	Function	Active	I/O	Handling when unused
S1/P1 to S4/P4 S5 to S38	1 to 4 5 to 38	Segment outputs for displaying the display data transferred by serial data input. The S1/P1 to S4/P4 pins can be used as general-purpose output ports under serial data control.	_	0	OPEN
COM1 to COM3 COM4/S39	42 to 40 39	Common driver outputs The frame frequency is fo [Hz] The COM4/S39 pin can be used as a segment output in 1/3 duty.	_	0	OPEN
KS1/S40 KS2/S41 KS3/S42 KS4 to KS6	43 44 45 46 to 48	Key scan outputs Although normal key scan timing lines require diodes to be inserted in the timing lines to prevent shorts, since these outputs are unbalanced CMOS transistor outputs, these outputs will not be damaged by shorting when these outputs are used to form a key matrix. The KS1/S40 to KS3/S42 pins can be used as segment outputs when so specified by the control data.		0	OPEN
KI1 to KI5	49 to 53	Key scan inputs These pins have built-in pull-down resistors.	Н	I	GND
OSC	60	The OSC pin can be used to form an oscillator circuit with an external resistor and an external capacitor. If external clock mode is selected with the control data, this pin is used to input an external clock signal.		I/O	V _{DD}
CE CL DI	62 63 64	Serial data interface connections to the controller. Note that DO, being an open-drain output, requires a pull-up resistor. CE: Chip enable CL: Synchronization clock	н		GND
DO	61	DI :Transfer data DO :Output data	_	0	OPEN
TEST	59	This pin must be connected to ground.	_	I	_
V _{LCD} 1	56	Used for applying the LCD drive 2/3 bias voltage externally. Must be connected to $V_{LCD}2$ when a 1/2 bias drive scheme is used.	_	I	OPEN
V _{LCD} 2	57	Used for applying the LCD drive $1/3$ bias voltage externally. Must be connected to $V_{\rm LCD}1$ when a $1/2$ bias drive scheme is used.		I	OPEN
V _{DD}	54	Logic block power supply connection. Provide a voltage of between 2.7 and 6.0V.	_	_	_
V _{LCD}	55	LCD driver block power supply connection. A voltage in the range $0.75 \times \text{VDD}$ to 6.0 V must be provided when VDD is in the range 3.6 to 6.0 V , and a voltage in the range 2.7 V to 6.0 V must be provided when VDD is in the range $2.7 \text{ to } 3.6 \text{ V}$.		_	_
V _{SS}	58	Power supply connection. Connect to ground.		_	_



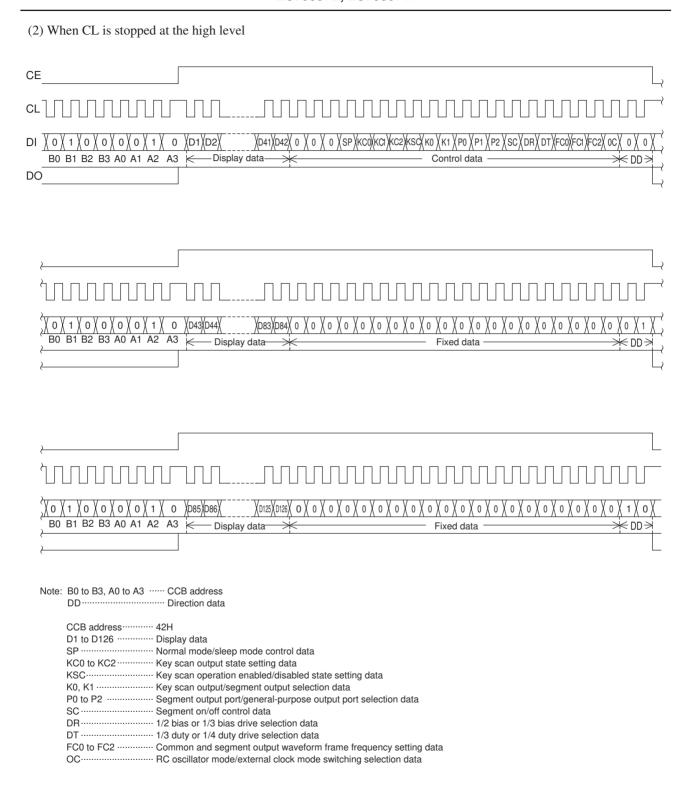
Fixed data

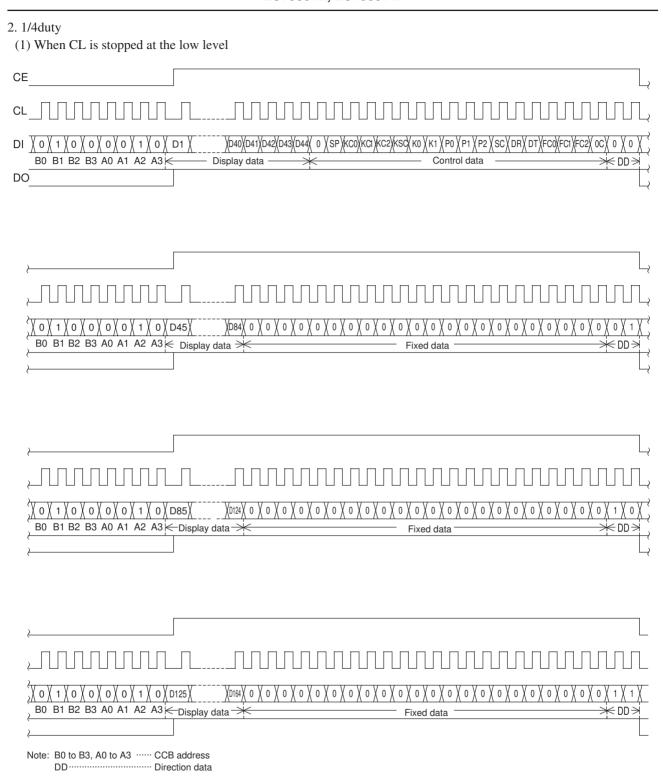
Note: B0 to B3, A0 to A3 ······ CCB address DD······ Direction data

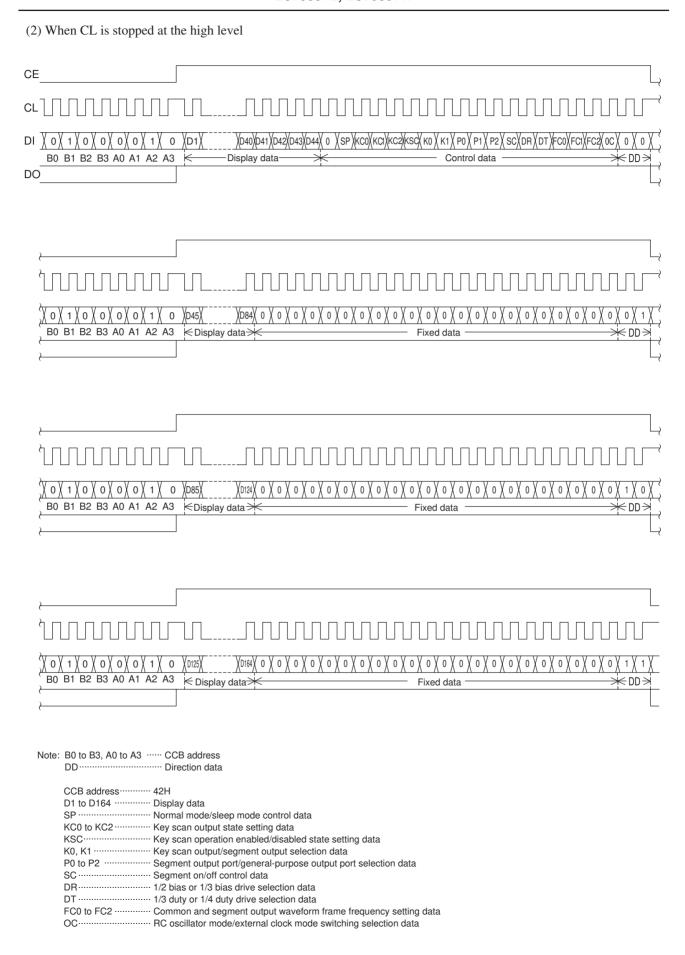
B0 B1 B2 B3 A0 A1 A2 A3

- Display data

 \dot{st} DD \dot{st}







Control Data Functions

1. SP: Normal mode/sleep mode control data This control data bit switches the IC between normal mode and sleep mode.

SP	Mode	OSC	pin state	Common and segment	Key scan	General-purpose
	Mode	RC oscillator mode	External clock mode	pin output states	operating state	output port states
0	Normal	Oscillator operating	External clock signal accepted	LCD drive waveforms		
				are output		
1	sleep	Oscillator stopped	Acceptance of the external		The state can be set	The state can be set
		(The oscillator operates	clock signal is disabled.		The state can be set	The state can be set
		during key scan operations.)	(The external clock signal is accepted	L (VSS)		
			during key scan operations)			

See the descriptions of the KC0 to KC2, KSC, K0, K1, and P0 to P2 bits in the control data for details on setting the key scanoperating state and setting the general-purpose output port state.

2. KC0 to KC2: Key scan output state setting data

These control data bits set the states of the key scan output pins KS1 to KS6.

	Control data	a		Output pi	n states du	ring key sc	an standby	
KC0	KC1	KC2	KS1	KS2	KS3	KS4	KS5	KS6
0	0	0	Н	Н	Н	Н	Н	Н
0	0	1	L	Н	Н	Н	Н	Н
0	1	0	L	L	Н	Н	Н	Н
0	1	1	L	L	L	Н	Н	Н
1	0	0	L	L	L	L	Н	Н
1	0	1	L	L	L	L	L	Н
1	1	0	L	L	L	L	L	L

This assumes that the KS1/S40 to KS3/S42 output pins are selected for key scan output. Note: Also note that key scan output signals are not output from output pins that are set to the low level.

3. KSC: Key scan operation enabled/disabled state setting data

This control data bit enables or disables key scan operation.

KSC	Key scan operating state
0	Key scan operation enabled (A key scan operation is performed if any key on the lines corresponding to KS1 to KS6 pin which is set high is pressed.)
1	Key scan operation disabled (No key scan operation is performed, even if any of the keys in the key matrix are pressed. If this state is set up, the key data is forcibly reset to 0 and the key data read request is also cleared. (DO is set high.))

4. K0, K1: Key scan output /segment output selection data

These control data bits switch the functions of the KS1/S40 to KS3/S42 output pins between key scan output and segment output.

Contro	ol data	Output pin state			Maximum number of
K0	K1	KS1/S40	KS2/S41	KS3/S42	input keys
0	0	KS1	KS2	KS3	30
0	1	S40	KS2	KS3	25
1	0	S40	S41	KS3	20
1	1	S40	S41	S42	15

Note: KSn(n = 1 to 3): Key scan output Sn (n = 40 to 42): Segment output 5. P0 to P2: Segment output port/general-purpose output port selection data

These control data bits switch the functions of the S1/P1 to S4/P4 output pins between the segment output port and the general-purpose output port.

Control data				Output	pin state	
P0	P1	P2	S1/P1	S2/P2	S3/P3	S4/P4
0	0	0	S1	S2	S3	S4
0	0	1	P1	S2	S3	S4
0	1	0	P1	P2	S3	S4
0	1	1	P1	P2	P3	S4
1	0	0	P1	P2	P3	P4

Note: Sn(n=1 to 4): Segment output port

Pn(n=1 to 4): General-purpose output port

The table below lists the correspondence between the display data and the output pins when these pins are selected to be general-purpose output ports.

Output pip	Corresponding display data		
Output pin	1/3 duty	1/4 duty	
S1/P1	D1	D1	
S2/P2	D4	D5	
S3/P3	D7	D9	
S4/P4	D10	D13	

For example, if the circuit is operated in 1/4 duty and the S4/P4 output pin is selected to be a general-purpose output port, the S4/P4 output pin will output a high level (V_{LCD}) when the display data D13 is 1, and will output a low level (V_{LCD}) when D13 is 0.

6. SC: Segment on/off control data

This control data bit controls the on/off state of the segments.

SC	Display state
0	on
1	off

However, note that when the segments are turned off by setting SC to 1, the segments are turned off by outputting segment off waveforms from the segment output pins.

7. DR: 1/2 bias or 1/3 bias drive selection data

This control data bit switches between LCD 1/2 bias or 1/3 bias drive.

DR	Bias drive scheme	
0	1/3 bias drive	
1	1/2 bias drive	

8. DT: 1/3 duty or 1/4 duty drive selection data

This control data bit switches between LCD 1/3 duty or 1/4 duty drive.

DT	Duty drive scheme	Output pin state (COM4/S39)	
0	1/4 duty drive	COM4	
1	1/3 duty drive	S39	

Note: COM4: Common output S39 : Segment output 9. FC0 to FC2: Common and segment output waveform frame frequency setting data These control data bits set the common and segment output waveform frequency.

Control data			Frame frequency, fo (Hz)		
FC0	FC1	FC2	Frame frequency, to (H2)		
0	0	0	f _{OSC} /768, f _{CK} /768		
0	0	1	f _{OSC} /576, f _{CK} /576		
0	1	0	f _{OSC} /384, f _{CK} /384		
0	1	1	f _{OSC} /288, f _{CK} /288		
1	0	0	f _{OSC} /192, f _{CK} /192		

10. OC : RC oscillator mode/external clock mode switching selection data

This control data bit selects the OSC pin function (RC oscillator mode or external clock mode).

ОС	OSC pin function
0	RC oscillator mode
1	External clock mode

Note: If RC oscillator mode is selected, connect an external resistor Rosc and an external capacitor Cosc to the OSC pin.

Display Data and Output Pin Correspondence

1. 1/3 duty

Output pin	COM1	COM2	сомз	Output pin	COM1	COM2	СОМЗ
S1/P1	D1	D2	D3	S22	D64	D65	D66
S2/P2	D4	D5	D6	S23	D67	D68	D69
S3/P3	D7	D8	D9	S24	D70	D71	D72
S4/P4	D10	D11	D12	S25	D73	D74	D75
S5	D13	D14	D15	S26	D76	D77	D78
S6	D16	D17	D18	S27	D79	D80	D81
S7	D19	D20	D21	S28	D82	D83	D84
S8	D22	D23	D24	S29	D85	D86	D87
S9	D25	D26	D27	S30	D88	D89	D90
S10	D28	D29	D30	S31	D91	D92	D93
S11	D31	D32	D33	S32	D94	D95	D96
S12	D34	D35	D36	S33	D97	D98	D99
S13	D37	D38	D39	S34	D100	D101	D102
S14	D40	D41	D42	S35	D103	D104	D105
S15	D43	D44	D45	S36	D106	D107	D108
S16	D46	D47	D48	S37	D109	D110	D111
S17	D49	D50	D51	S38	D112	D113	D114
S18	D52	D53	D54	COM4/S39	D115	D116	D117
S19	D55	D56	D57	KS1/S40	D118	D119	D120
S20	D58	D59	D60	KS2/S41	D121	D122	D123
S21	D61	D62	D63	KS3/S42	D124	D125	D126

Note: This is for the case where the output pins S1/P1 to S4/P4, COM4/S74, KS1/S40 to KS3/S42 are selected for use as segment outputs.

For example, the table below lists the segment output states for the S11 output pin.

Display data		a	Output his state (C11)				
D31	D32	D33	Output pin state (S11)				
0	0	0	The LCD segments for COM1, COM2 and COM3 are off.				
0	0	1	The LCD segment for COM3 is on.				
0	1	0	The LCD segment for COM2 is on.				
0	1	1	The LCD segments for COM2 and COM3 are on.				
1	0	0	The LCD segment for COM1 is on.				
1	0	1	The LCD segments for COM1 and COM3 are on.				
1	1	0	The LCD segments for COM1 and COM2 are on.				
1	1	1	The LCD segments for COM1, COM2 and COM3 are on.				

2. 1/4 duty

Output pin	COM1	COM2	COM3	COM4
S1/P1	D1	D2	D3	D4
S2/P2	D5	D6	D7	D8
S3/P3	D9	D10	D11	D12
S4/P4	D13	D14	D15	D16
S5	D17	D18	D19	D20
S6	D21	D22	D23	D24
S7	D25	D26	D27	D28
S8	D29	D30	D31	D32
S9	D33	D34	D35	D36
S10	D37	D38	D39	D40
S11	D41	D42	D43	D44
S12	D45	D46	D47	D48
S13	D49	D50	D51	D52
S14	D53	D54	D55	D56
S15	D57	D58	D59	D60
S16	D61	D62	D63	D64
S17	D65	D66	D67	D68
S18	D69	D70	D71	D72
S19	D73	D74	D75	D76
S20	D77	D78	D79	D80
S21	D81	D82	D83	D84

Output pin	COM1	COM2	СОМЗ	COM4
S22	D85	D86	D87	D88
S23	D89	D90	D91	D92
S24	D93	D94	D95	D96
S25	D97	D98	D99	D100
S26	D101	D102	D103	D104
S27	D105	D106	D107	D108
S28	D109	D110	D111	D112
S29	D113	D114	D115	D116
S30	D117	D118	D119	D120
S31	D121	D122	D123	D124
S32	D125	D126	D127	D128
S33	D129	D130	D131	D132
S34	D133	D134	D135	D136
S35	D137	D138	D139	D140
S36	D141	D142	D143	D144
S37	D145	D146	D147	D148
S38	D149	D150	D151	D152
KS1/S40	D153	D154	D155	D156
KS2/S41	D157	D158	D159	D160
KS3/S42	D161	D162	D163	D164

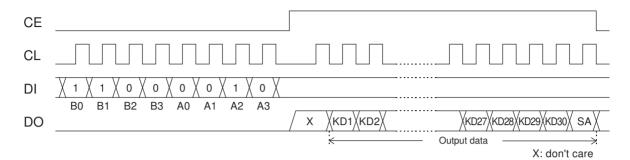
Note: This is for the case where the output pins S1/P1 to S4/P4, KS1/S40 to KS3/S42 are selected for use as segment outputs.

For example, the table below lists the segment output states for the S11 output pin.

	Display data			Output his state (C11)		
D41	D42	D43	D44	Output pin state (S11)		
0	0	0	0	The LCD segments for COM1,COM2,COM3 and COM4 are off.		
0	0	0	1	The LCD segment for COM4 is on.		
0	0	1	0	The LCD segment for COM3 is on.		
0	0	1	1	The LCD segments for COM3 and COM4 are on.		
0	1	0	0	The LCD segment for COM2 is on.		
0	1	0	1	The LCD segments for COM2 and COM4 are on.		
0	1	1	0	The LCD segments for COM2 and COM3 are on.		
0	1	1	1	The LCD segments for COM2,COM3 and COM4 are on.		
1	0	0	0	The LCD segment for COM1 is on.		
1	0	0	1	The LCD segments for COM1 and COM4 are on.		
1	0	1	0	The LCD segments for COM1 and COM3 are on.		
1	0	1	1	The LCD segments for COM1,COM3 and COM4 are on.		
1	1	0	0	The LCD segments for COM1 and COM2 are on.		
1	1	0	1	The LCD segments for COM1,COM2 and COM4 are on.		
1	1	1	0	The LCD segments for COM1,COM2 and COM3 are on.		
1	1	1	1	The LCD segments for COM1,COM2,COM3 and COM4 are on.		

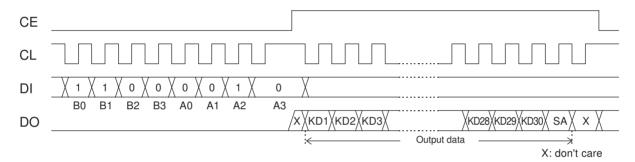
Serial Data Output

1. When CL is stopped at the low level



Note: B0 to B3, A0 to A3······CCB address

2. When CL is stopped at the high level



Note: B0 to B3, A0 to A3.....CCB address

CCB address ······ 43H KD1 to KD30······ Key data

SA Sleep acknowledge data

Note: If a key data read operation is executed when DO is high, the read key data (KD1 to KD30) and sleep acknowledge data(SA) will be invalid.

Output Data

1. KD1 to KD30: Key data

When a key matrix of up to 30 keys is formed from the KS1 to KS6 output pins and the KI1 to KI5 input pins and one of those keys is pressed, the key output data corresponding to that key will be set to 1. The table shows the relationship between those pins and the key data bits.

	KI1	KI2	KI3	KI4	KI5
KS1/S40	KD1	KD2	KD3	KD4	KD5
KS2/S41	KD6	KD7	KD8	KD9	KD10
KS3/S42	KD11	KD12	KD13	KD14	KD15
KS4	KD16	KD17	KD18	KD19	KD20
KS5	KD21	KD22	KD23	KD24	KD25
KS6	KD26	KD27	KD28	KD29	KD30

When the KS1/S40 and KS2/S41 output pins are selected to be segment outputs by control data bits K0 and K1 and a key matrix of up to 20 keys is formed using the KS3/S42,KS4 to KS6 output pins and the KI1 to KI5 input pins, the KD1 to KD10 key data bits will be set to 0.

2. SA: Sleep acknowledge data

This output data bit is set to the state when the key was pressed. Also, while DO will be low in this case, if serial data is input and the mode is set (to normal or sleep mode) during this period, that mode will be set. SA will be 1 in sleep mode and 0 in normal mode.

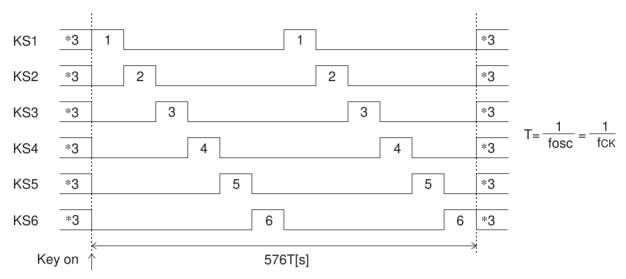
Sleep Mode Functions

Sleep mode is set up by setting SP in the control data to 1. When sleep mode is set up, both the segment and the common outputs will go to the low level. In RC oscillator mode (OC = 0), the oscillator on the OSC pin will stop (although it will operate during key scan operations), and in external clock mode (OC = 1), the external clock signal reception on the OSC pin will stop (although the clock signal will be received during key scan operations). Thus this mode reduces power consumption. However, the S1/P1 to S4/P4 output pins can be used as general-purpose output ports under control of the P0 to P2 bits in the control data even in sleep mode. Sleep mode is cancelled by setting SP in the control data to 0.

Key Scan Operation Functions

1. Key scan timing

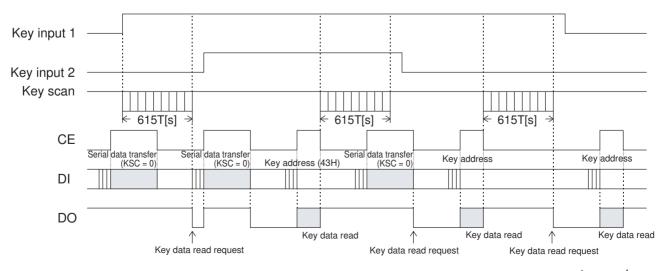
The key scan period is 288T(s). To reliably determine the on/off state of the keys, the LC75857E/W scans the keys twice and determines that a key has been pressed when the key data agrees. It outputs a key data read request (a low level on DO) 615T(s) after starting a key scan. If the key data dose not agree and a key was pressed at that point, it scans the keys again. Thus the LC75857E/W cannot detect a key press shorter than 615T(s).



Note: *3. These are set to the high or low level by the KC0 to KC2 bits in the control data. Key scan output signals are not output from pins that are set to the low level.

2. Normal mode, when key scan operations are enabled

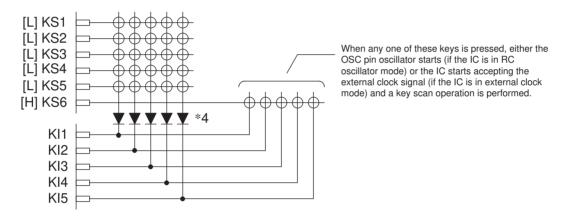
- The KS1 to KS6 pins are set to the high or low level by the KC0 to KC2 bits in the control data. (See the description of the control data.)
- When any key on the lines corresponding to KS1 to KS6 pin which is set high is pressed, a key scan is performed. Keys are scanned until all keys are released. Multiple key presses are recognized by determining whether multiple key data bits are set.
- If a key is pressed for longer than 615 T (s) (Where $T = \frac{1}{fosc} = \frac{1}{fCK}$) the LC75857E/W outputs a key data read request (a low level on DO) to the controller. The controller acknowledges this request and reads the key data. However, if CE is high during a serial data transfer, DO will be set high.
- After the controller reads the key data, the key data read request is cleared (DO is set high) and the LC75857E/W performes another key scan. Also note that DO, being an open-drain output, requires a pull-up resistor (between 1 to 10 kΩ).



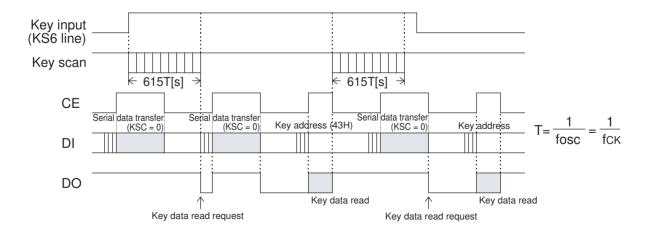
 $T = \frac{1}{\text{fosc}} = \frac{1}{\text{fCK}}$

- 3. Sleep mode, when key scan operations are enabled
 - The KS1 to KS6 pins are set to the high or low level by the KC0 to KC2 bits in the control data. (See the description of the control data.)
 - When any key on the lines corresponding to KS1 to KS6 pin which is set high is pressed, either the OSC pin oscillator starts (if the IC is in RC oscillator mode) or the IC starts accepting the external clock signal (if the IC is in external clock mode), a key scan is performed. Keys are scanned until all keys are released. Multiple key presses are recognized by determining whether multiple key data bits are set.
 - If a key is pressed for longer than 615T(s)(Where $T = \frac{1}{fosc} = \frac{1}{fCK}$) the LC75857E/W outputs a key data read request (a low level on DO) to the controller. The controller acknowledges this request and reads the key data. However, if CE is high during a serial data transfer, DO will be set high.
 - After the controller reads the key data, the key data read request is cleared (DO is set high) and the LC75857E/W performs another key scan. However, this dose not clear sleep mode. Also note that DO, being an open-drain output, requires a pull-up resistor (between 1 and 10 k Ω).
 - Sleep mode key scan example

Example: KC0 = 1, KC1 = 0, KC2 = 1, (sleep with only KS6 high)

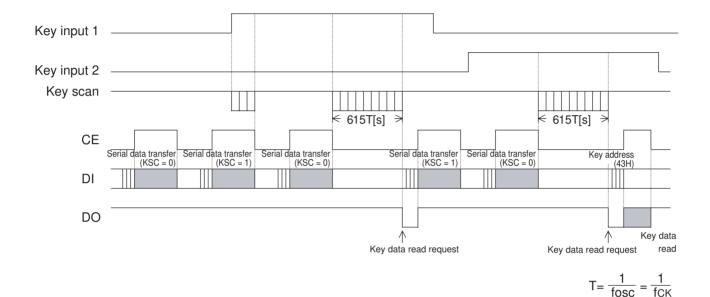


Note: *4. These diodes are required to reliable recognize multiple key presses on the KS6 line when sleep mode state with only KS6 high, as in the above example. That is, these diodes prevent incorrect operations due to sneak currents in the KS6 key scan output signal when keys on the KS1 to KS5 lines are pressed at the same time.



Page 19

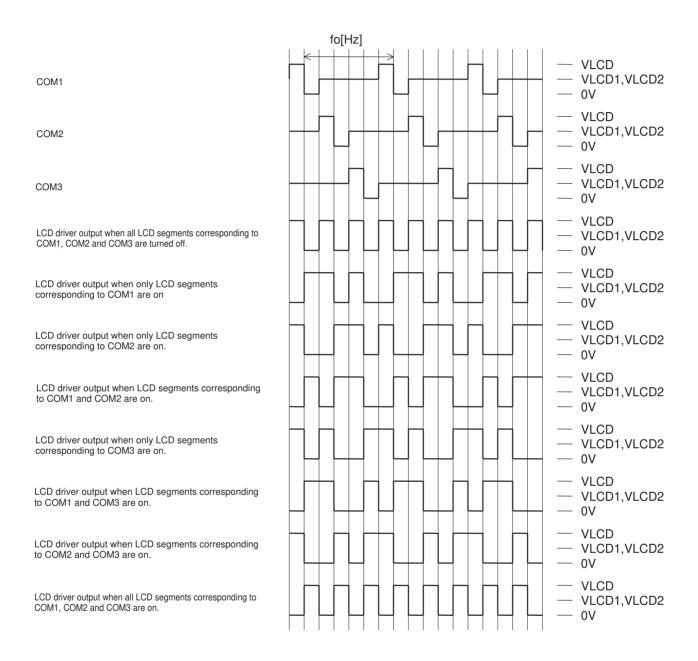
- 4. Normal/sleep mode, when key scan operations are disabled
 - The KS1 to KS6 pins are set to the high or low level by the KC0 to KC2 bits in the control data.
 - No key scan operation is performed, whichever key is pressed.
 - If the key scan disabled state (KSC = 1 in the control data) is set during a key scan, the key scan is stopped.
 - If the key scan disabled state (KSC = 1 in the control data) is set when a key data read request (a low level on DO) is output to the controller, all the key data is set to 0 and the key data read request is cleared (DO is set high). Note that DO, being an open-drain output, requires a pull-up resister (between 1 to 10 kΩ).
 - The key scan disabled state is cleared by setting KSC in the control data to 0.



Multiple Key Presses

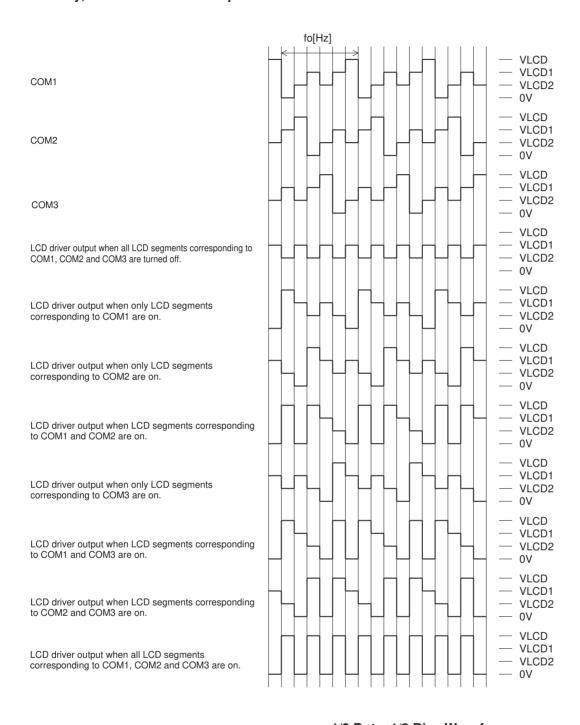
Although the LC75857E/W is capable of key scanning without inserting diodes for dual key presses, triple key presses on the K11 to K15 input pin lines, or multiple key presses on the K51 to K56 output pin lines, multiple presses other than these cases may result in keys that were not pressed recognized as having been pressed. Therefore, a diode must be inserted in series with each key. Applications that do not recognize multiple key presses of three or more keys should check the key data for three or more 1 bits and ignore such data.

1/3 Duty, 1/2 Bias Drive Technique



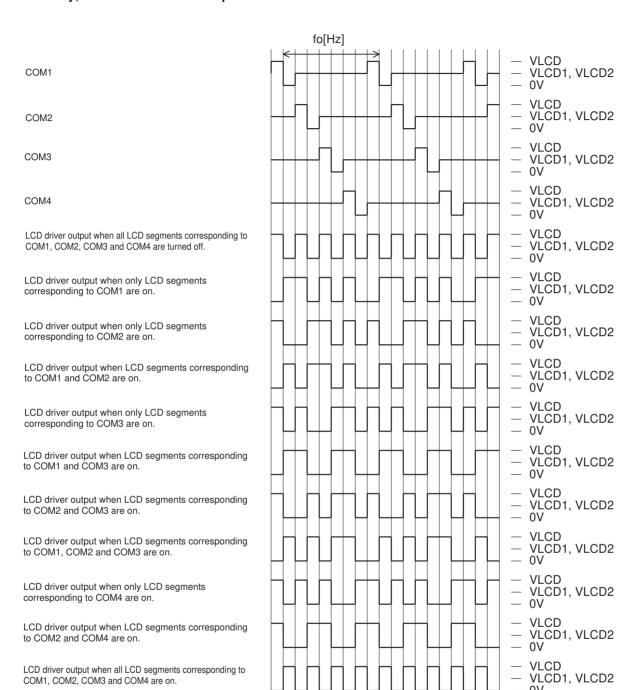
1/3 Duty, 1/2 Bias Waveforms

1/3 Duty, 1/3 Bias Drive Technique



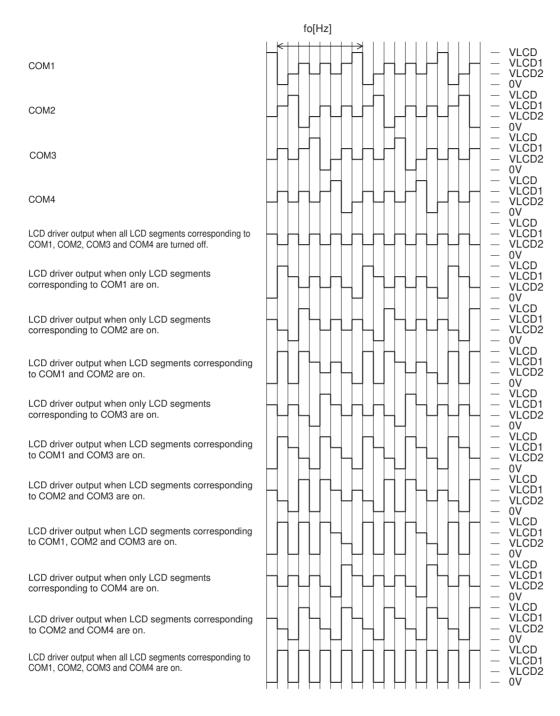
1/3 Duty, 1/3 Bias Waveforms

1/4 Duty, 1/2 Bias Drive Technique



1/4 Duty, 1/2 Bias Waveforms

1/4 Duty, 1/3 Bias Drive Technique



1/4 Duty, 1/3 Bias Waveforms

Voltage Detection Type Reset Circuit (VDET)

This circuit generates an output signal and resets the system when logic block power is first applied and when the voltage drops, i.e., when the logic block power supply voltage is less than or equal to the power down detection voltage VDET, which is 2.2V, typical. To assure that this function operates reliably, a capacitor must be added to the logic block power supply line so that the logic block power supply voltage V_{DD} rise time when the logic block power is first applied and the logic block power supply voltage V_{DD} fall time when the voltage drops are both at least 1 ms. (See Figure 5 and Figure 6.)

Power Supply Sequence

The following sequences must be observed when power is turned on and off. (See Figure 5 and Figure 6.)

- Power on :Logic block power supply(V_{DD}) on \rightarrow LCD driver block power supply(V_{LCD}) on
- $\bullet \ \ \text{Power off:LCD driver block power supply}(V_{LCD}) \ \text{off} \rightarrow Logic \ block \ power \ supply}(V_{DD}) \ \text{off}$

However, if the logic and LCD driver block use a shared power supply, then the power supplies can be turned on and off at the same time.

System Reset

The LC75857E/W supports the reset methods described below. When a system reset is applied, display is turned off, key scanning is stopped, and all the key data is reset to low. When the reset is cleared, display is turned on and key scanning become possible.

1. Reset methods

If at least 1 ms is assured as the logic block supply voltage V_{DD} rise time when logic block power is applied, a system reset will be applied by the VDET output signal when the logic block supply voltage is brought up. If at least 1 ms is assured as the logic block supply voltage V_{DD} fall time when logic block power drops, a system reset will be applied in the same manner by the VDET output signal when the supply voltage is lowered. Note that the reset is cleared at the point when all the serial data (1/3 duty: the display data D1 to D126 and the control data, 1/4 duty: the display data D1 to D164 and the control data) has been transferred, i.e., on the fall of the CE signal on the transfer of the last direction data, after all the direction data has been transferred. (See Figure 5 and Figure 6.)